

GV-5260SE-C-HQ (AB02005)

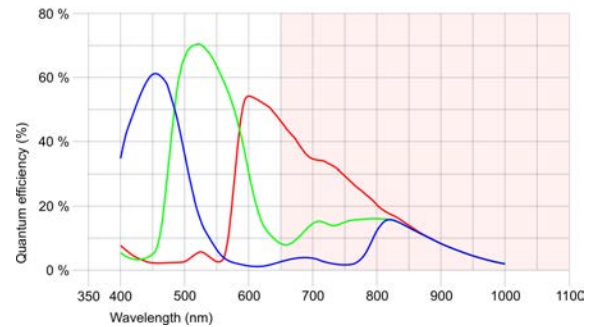
NEW GENERATION



Specification

Sensor

Sensor type	CMOS Color
Shutter	Global Shutter
Sensor characteristic	Linear
Readout mode	Progressive scan
Pixel Class	2 MP
Resolution	2.30 Mpix
Resolution (h x v)	1920 x 1200 Pixel
Aspect ratio	16:10
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/1.2"
Optical Size	11.250 mm x 7.030 mm
Optical sensor diagonal	13.27 mm (1/1.21")
Pixel size	5.86 µm
Manufacturer	Sony
Sensor Model	IMX249LQJ-C
Gain (master/RGB)	24x/4x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	96 / 8
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	8 / 2
Binning horizontal	-
Binning vertical	-
Binning method	-
Binning factor	-
Subsampling horizontal	same frame rate
Subsampling vertical	same frame rate
Subsampling method	M/C automatic
Subsampling factor	2, 4, 8



GV-5260SE-M-GL (AB02006)

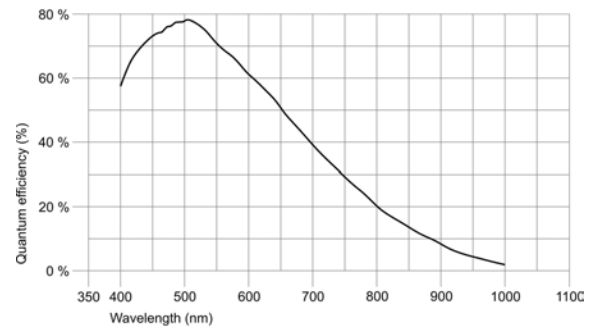
NEW GENERATION



Specification

Sensor

Sensor type	CMOS Mono
Shutter	Global Shutter
Sensor characteristic	Linear
Readout mode	Progressive scan
Pixel Class	2 MP
Resolution	2.30 Mpix
Resolution (h x v)	1920 x 1200 Pixel
Aspect ratio	16:10
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/1.2"
Optical Size	11.250 mm x 7.030 mm
Optical sensor diagonal	13.27 mm (1/1.21")
Pixel size	5.86 µm
Manufacturer	Sony
Sensor Model	IMX249LLJ-C
Gain (master/RGB)	24x/4x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	96 / 8
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	8 / 2
Binning horizontal	-
Binning vertical	-
Binning method	-
Binning factor	-
Subsampling horizontal	same frame rate
Subsampling vertical	same frame rate
Subsampling method	M/C automatic
Subsampling factor	2, 4, 8



Model

Pixel clock range	99 MHz - 118 MHz
Frame rate freerun mode	46
Frame rate trigger (maximum)	-
Exposure time (minimum - maximum)	0.031 ms - 2000 ms
Power consumption	1.7 W - 2.9 W
Image memory	128 MB

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

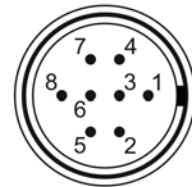
Device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45, screwable
I/O connector	8-pin Hirose connector (HR25-7TR-8PA(73))
Power supply	12 V - 24 V or PoE

Pin assignment I/O connector

1	Ground (GND)
2	Flash output with optocoupler (-)
3	General Purpose I/O (GPIO) 1
4	Trigger input with optocoupler (-)
5	Flash output with optocoupler (+)
6	General Purpose I/O (GPIO) 2
7	Trigger input with optocoupler (+)
8	Input power supply (VCC) 12-24 V DC



Camera rear view

Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	34.0 mm x 44.0 mm x 47.0 mm
Mass	106 g